

dfw



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 5731**
Akihisa HONGO et al. : Docket No. 2001_0133A
Serial No. 09/762,582 : Group Art Unit 1753
Filed April 12, 2001 : Examiner Brian Mutschler

SUBSTRATE PLATING METHOD AND APPARATUS

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED
TO CHANGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

Sir:

In response to the Office Action of June 2, 2004, please amend the above-identified U.S. Patent application as follows: